

1N3004W Silicon Epitaxial Planar Diode

High Voltage Switching Diode

Features

- · Fast switching speed
- High Conductance
- High Reverse Breakdown Voltage

PINNING PIN DESCRIPTION 1 Cathode 2 Anode Top View Marking Code: JX Simplified outline SOD-123 and symbol

Absolute Maximum Ratings (T_a = 25_oC)

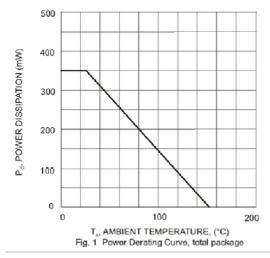
Parameter		Symbol	Value	Unit
Repetitive Peak Reverse Voltage		Vrrm	350	V
Working Peak Reverse Voltage		V _{RWM}	300	V
Reverse Voltage		V _R	300	V
Continuous Forward Current		l _F	225	mA
Peak Repetitive Forward Current		IFRM	625	mA
Non-Repetitive Peak Forward Surge Current	at t = 1 µs at t = 1 s	Ігэм	4 1	А
Power Dissipation		P_d	350	mW
Operating and Storage Temperature Range		Tj, Tstg	- 65 to + 150	оC

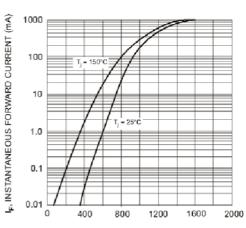
Characteristics at $T_a = 25 \, {}_{\circ}C$

Parameter	Symbol	Min.	Max.	Unit
Forward Voltage at $I_F = 20 \text{ mA}$ at $I_F = 100 \text{ mA}$ at $I_F = 200 \text{ mA}$	V _F		0.87 1 1.25	V
Reverse Current at $V_R = 240 \text{ V}$ at $V_R = 240 \text{ V}$, $T_i = 150 {}_{\circ}\text{C}$	I _R	-	100 100	nA μA
Reverse Breakdown Voltage at I _R = 100 μA	$V_{(BR)R}$	300	-	V
Total Capacitance at $V_R = 0$, $f = 1$ MHz	Ст	-	5	pF
Reverse Recovery Time at $I_F = I_R = 30$ mA, $i_{rr} = 0.1$ I_R , $R_L = 100$ Ω	t _{rr}	-	50	ns

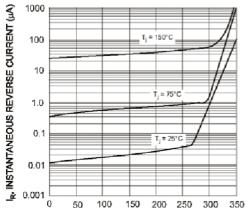


Typical Characteristics

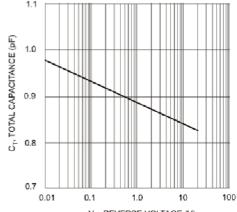




V_F, INSTANTANEOUS FORWARD VOLTAGE (mV) Fig. 2 Typical Forward Characteristics, per element



 $V_{\rm R}$, INSTANTANEOUS REVERSE VOLTAGE (V) Fig. 3 Typical Reverse Characteristics, per element



V_R, REVERSE VOLTAGE (V) Fig. 4 Typical Total Capacitance vs. Reverse Voltage, per element



PACKAGE OUTLINE

Plastic surface mounted package; 2 leads

SOD-123

